# 776280-6 SUPERSEDED

#### AMP | AMPSEAL

TE Internal #: 776280-6

TE Internal Description: 8 POS RTANG HDR ASSY W/GASK & EXT.

FLANG

AMPSEAL PCB Right-Angle Headers

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Connector System: Wire-to-Board

Number of Positions: 8

Centerline (Pitch): 4 mm [ .157 in ]

Sealable: Yes

PCB Mount Orientation: Right Angle

All AMPSEAL PCB Right-Angle Headers (63)

#### **Features**

#### **Product Type Features**

Mixed & Hybrid Header	No
Connector Shape	Rectangular
PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board
Sealable	Yes
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Sections	1
Number of Signal Positions	8
Number of Positions	8
PCB Mount Orientation	Right Angle
Number of Rows	3



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ating Retention Type	ocking Interface
onnector Mounting Type B	Board Mount
using Features	
enterline (Pitch) 4	1 mm[.157 in]
nensions	
onnector Length 4	10.8 mm[1.6 in]
onnector Width 3	37.9 mm[1.5 in]
CB Thickness (Recommended) 1	1.5 – 1.6 mm[.06 – .063 in]
rofile Height from PCB 2	27.9 mm[1.1 in]
ige Conditions	



Operating Temperature (Max)	125 °C[257 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
Degree of Protection	IP6K9K
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	280
Packaging Method	Tray

#### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

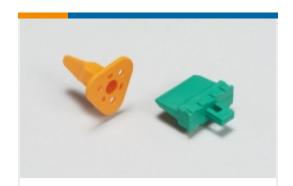
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

### Also in the Series | AMPSEAL





Automotive Connector Locks & Position Assurance(1)



Automotive Housings(31)



Automotive Terminals(8)





Connector Seals & Cavity Plugs(2)



# Customers Also Bought



REC, 2P, GRY, N



PLG, 2P, GRY, N













## **Documents**

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_776280-6\_H.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_776280-6\_H.3d\_igs.zip



English

**Customer View Model** 

ENG\_CVM\_CVM\_776280-6\_H.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

AMPSEAL Connector Catalog

English

ICT Terminals and Connectors Catalogue

English

**Product Specifications** 

**Application Specification** 

English